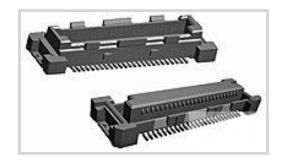


Free Height

TE Internal #: 1-5316562-1 Free Height, PCB Mount Header, Vertical, Board-to-Board, 160 Position, .6mm [.024in] Centerline, Gold, Printed Circuit Board View on TE.com >



Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 160

Centerline (Pitch): .6 mm [.024 in]

Features

Product Type Features

Ground Component Type

PCB Connector Assembly Type

Connector System

Connector & Contact Terminates To

Grounding Contact, Grounding Plate

PCB Mount Header

Board-to-Board

Printed Circuit Board

Configuration Features

Number of Rows	2
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	160
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	200 VAC
Insulation Resistance	2 ΜΩ
Operating Voltage	50 VAC
Contact Features	
Contact Layout	Inline
Contact Mating Area Length	1 mm, 1.3 mm
PCB Contact Termination Area Plating Material Thickness	1 μm[39.37 μin]
Mating Tab Width	.3 mm[.012 in]

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Free Height, PCB Mount Header, Vertical, Board-to-Board, 160 Position, .6mm [. 024in] Centerline, Gold, Printed Circuit Board



Mating Tab Thickness	.2 mm[.008 in]
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.2 μm[7.874 μin]
Contact Type	Pin
Contact Current Rating (Max)	.5 A
Termination Features	
Square Termination Post & Tail Dimension	.2 mm[.008 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
PCB Mount Retention Type	Solder Peg
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.6 mm[.024 in]
Housing Color	Black
Housing Material	High Temperature Thermoplastic
Dimensions	
Connector Height	8 mm[.31 in]
Stack Height	8 mm, 16 mm[.63 in]
	.2 in
Usage Conditions	
Operating Temperature Range	-40 – 85 °C[-40 – 185 °F][-40 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0

Free Height, PCB Mount Header, Vertical, Board-to-Board, 160 Position, .6mm [. 024in] Centerline, Gold, Printed Circuit Board



Packaging Features

Packaging Quantity	30
Packaging Method	Soft Tray

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Free Height, PCB Mount Header, Vertical, Board-to-Board, 160 Position, .6mm [. 024in] Centerline, Gold, Printed Circuit Board





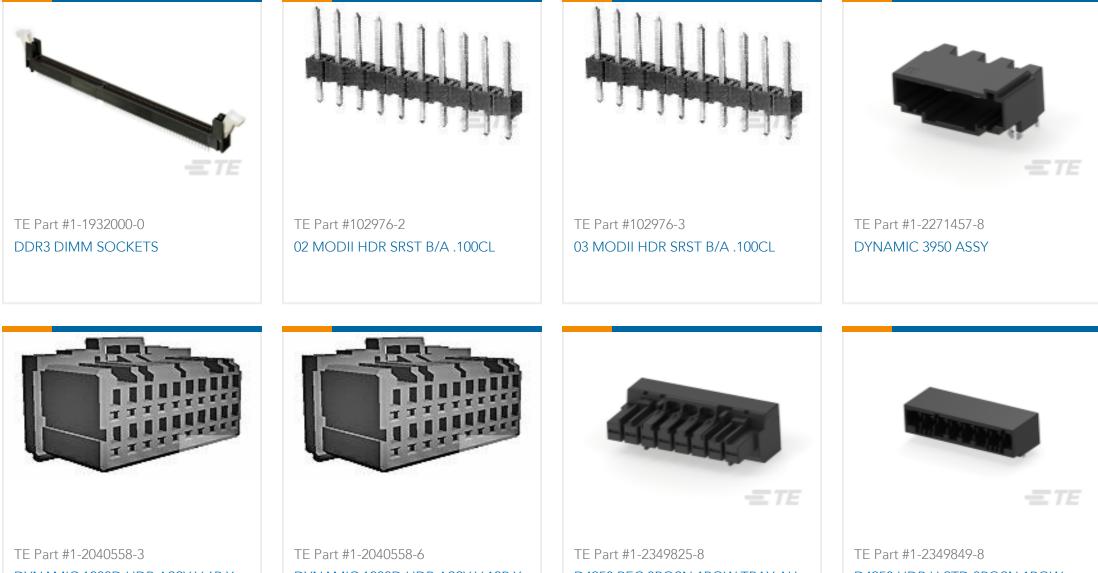
Also in the Series | Free Height



Board-to-Board Headers & Receptacles(764)

Customers Also Bought







TRAY AU



BLACK TIN

BLACK TIN

Free Height, PCB Mount Header, Vertical, Board-to-Board, 160 Position, .6mm [. 024in] Centerline, Gold, Printed Circuit Board



Documents

Product Drawings .6FHP08H,160,S,GIG,08/Sn,ST,NS

Japanese

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_1-5316562-1_O.2d_dxf.zip

English

Customer View Model

ENG_CVM_1-5316562-1_O.3d_igs.zip

English

Customer View Model

ENG_CVM_1-5316562-1_O.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

Datasheets & Catalog Pages

Fine Pitch Stacking Connectors - 0.6mm Free Height (FH) and GIGA Connectors

English

Product Specifications

Application Specification

English

Product Environmental Compliance

TE Material Declaration

English